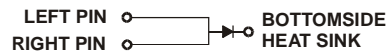
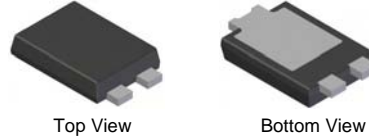


#### Features

- Schottky Barrier Chip
- Bypass Diodes for Solar Panels
- High Junction Temperature
- High Thermal Reliability
- Patented Super Barrier Rectifier Technology
- High Forward Surge Capability
- Ultra Low Power Loss, High Efficiency
- Excellent High Temperature Stability



Note: Pins Left & Right must be electrically connected at the printed circuit board.

#### Mechanical Data

- Case: TO-277B Molded Plastic "Green" Molding Compound
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Mounting Position: Any
- Marking: Type Number
- Lead Free: For RoHS/Lead Free Version

#### Maximum Ratings and Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Parameter	Symbol	SR 1045L	SR 1050L	SR 1060L	S R 1080L	SR 10100L	SR 10150L	SR 10200L	Unit	
Peak Repetitive Reverse Voltage	$V_{RRM}$									
Working Peak Reverse Voltage	$V_{RWM}$	45	50	60	80	100	150	200	V	
DC blocking voltage	$V_{DC}$									
RMS Rectified Voltage	$V_{R(RMS)}$	32	35	42	56	70	105	140	V	
Average Rectified Output Current (Note1)	$I_O$	10							A	
Non-Repetitive Peak Forward Surge 8.3ms Single Half Sine-Wave Superimposed on rated load (JEDEC Method) (Note2)	$I_{FSM}$	275							A	
$I^2t$ Rating for Fusing ( $t < 8.3\text{ms}$ )	$I^2t$	313.8							$\text{A}^2\text{s}$	
Forward Voltage Drop $T_A=25^\circ\text{C}$ @ $I_F=10\text{A}$	$V_{FM}$	0.42	0.45	0.47	0.70		0.85		V	
Peak Reverse Current $T_A=25^\circ\text{C}$ At Rated DC Blocking Voltage $T_A=100^\circ\text{C}$	$I_R$					0.3		15		mA
Typical Thermal Resistance Junction to Ambient	$R_{\theta JA}$ $R_{\theta JL}$					80		15		$^\circ\text{C}/\text{W}$
Operating junction temperature range	$T_J$	-55 to +150							$^\circ\text{C}$	
storage temperature range	$T_{STG}$	-55 to +150							$^\circ\text{C}$	

Note: 1. Valid Provided that are kept at ambient temperature at a distance of 9.5mm from the case.

2. Fr-4pcb. 2oz. Copper, minimum recommend pad layout .18.8mm×14.4. Anode pad dimensions 5.6mm×14.4mm.

FIG.1 - FORWARD CURRENT DERATING CURVE

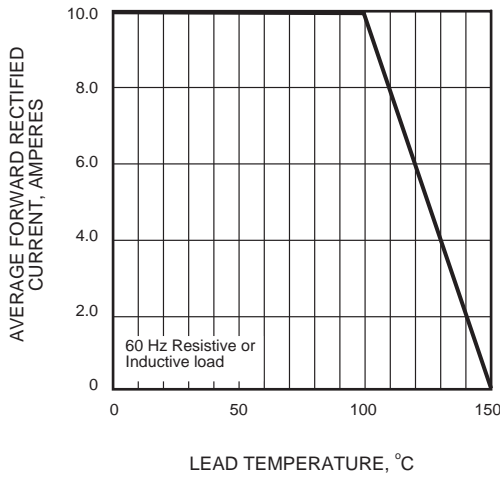


FIG.2 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

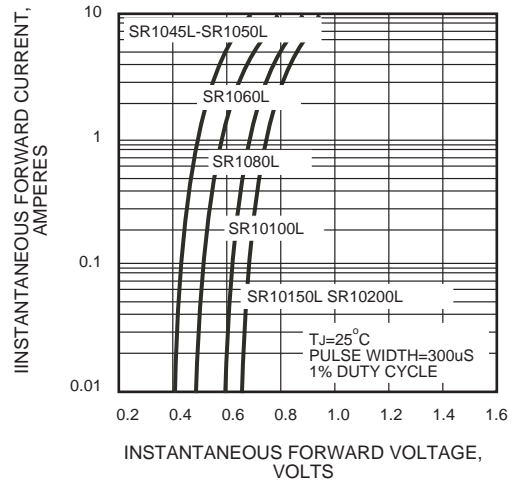


FIG.3 - MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

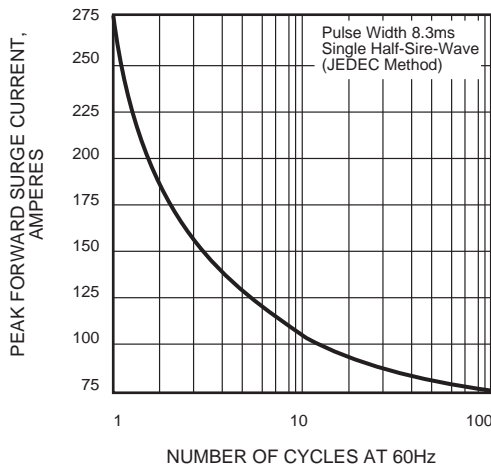


FIG.4 - TYPICAL REVERSE CHARACTERISTICS

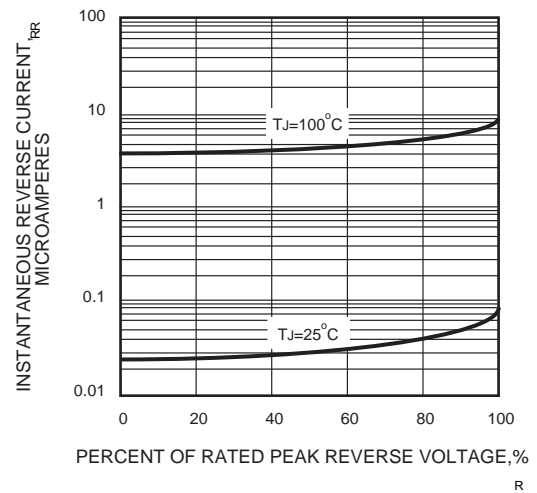
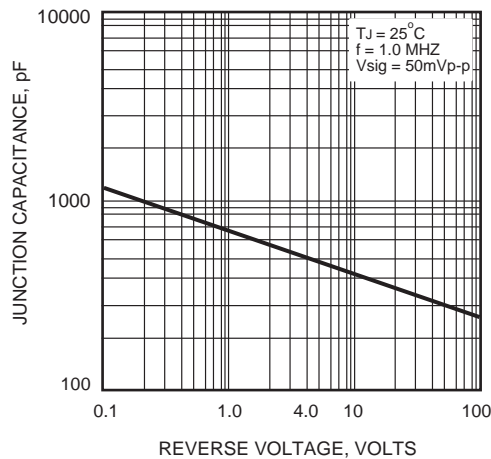


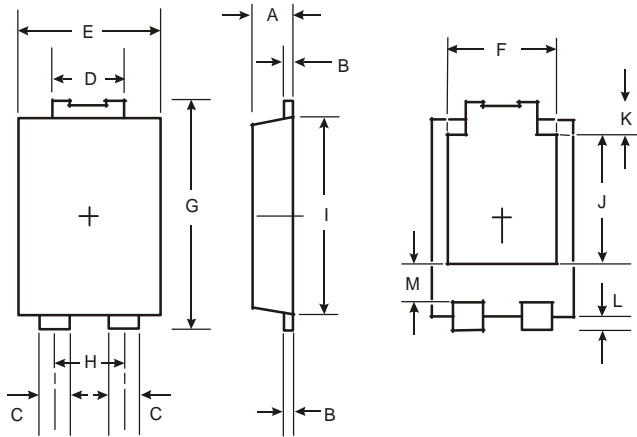
FIG.5 - TYPICAL JUNCTION CAPACITANCE



### Ordering Information

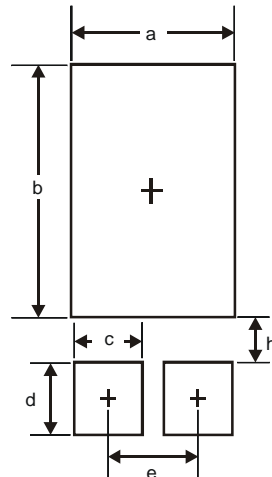
Part Number	Case	Packaging
SR10**L	TO-277B	5000/Tape & Reel

### Outline Dimensions



TO-277B		
Dim	Min	Max
A	1.05	1.15
B	0.33	0.43
C	0.80	0.99
D	1.70	1.88
E	3.90	4.05
F	3.054 Typ	
G	6.40	6.60
H	1.84 Typ	
I	5.30	5.45
J	3.549 Typ	
K	0.75	0.95
L	0.50	0.65
M	1.10	1.41
All Dimensions in mm		

### Suggested Pad Layout



Dimensions	Value (in mm)
a	3.360
b	4.860
c	1.390
d	1.400
e	1.840
h	0.852